



JMSL0401BG

## 40V 0.83mΩ N-Ch Power MOSFET

### Features

- Ultra-low  $R_{DS(ON)}$
- Low Gate Charge
- High Current Capability
- 100% UIS Tested, 100%  $R_g$  Tested

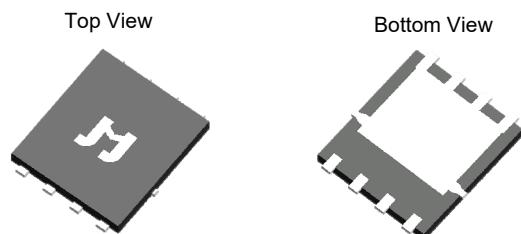
### Applications

- Power Management in Computing, CE, IE 4.0, Communications
- Current Switching in DC/DC & AC/DC (SR) Sub-systems
- Load Switching, Quick/Wireless Charging, Motor Driving

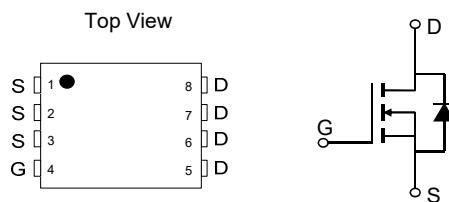
### Product Summary

Parameter	Value	Unit
$V_{DS}$	40	V
$V_{GS(th)}_{Typ}$	1.5	V
$I_D (@ V_{GS} = 10V)$ <sup>(1)</sup>	243	A
$R_{DS(ON)}_{Typ} (@ V_{GS} = 10V)$	0.83	mΩ
$R_{DS(ON)}_{Typ} (@ V_{GS} = 4.5V)$	1.2	mΩ

PDFN5x6-8L



Pin Configuration

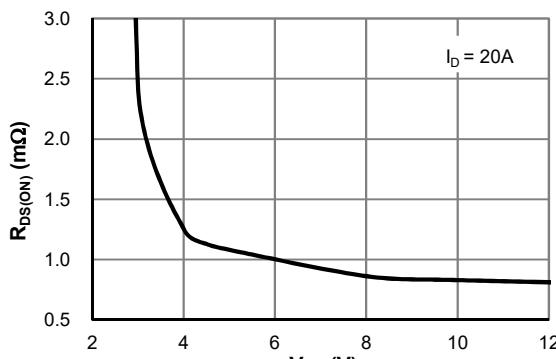


### Ordering Information

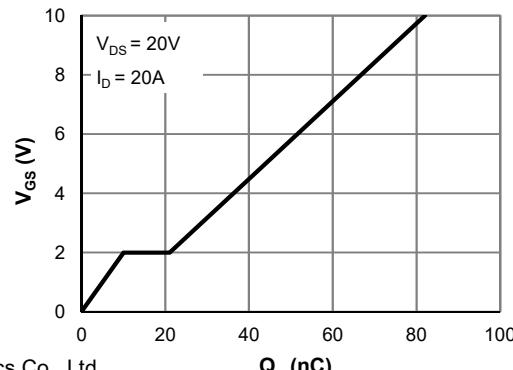
Device	Package	# of Pins	Marking	MSL	$T_J$ (°C)	Media	Quantity (pcs)
JMSL0401BG-13	PDFN5x6-8L	8	SL0401B	1	-55 to 150	13-inch Reel	3000

### Absolute Maximum Ratings (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	$V_{DS}$	40	V
Gate-to-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>(1)</sup>	$I_D$	243	A
$T_C = 100^\circ\text{C}$		153	
Continuous Drain Current <sup>(6)</sup>	$I_D$	100	A
Pulsed Drain Current <sup>(2)</sup>	$I_{DM}$	886	A
Avalanche Current <sup>(3)</sup>	$I_{AS}$	46	A
Avalanche Energy <sup>(3)</sup>	$E_{AS}$	317	mJ
Power Dissipation <sup>(4)</sup>	$P_D$	96	W
$T_C = 100^\circ\text{C}$		38	
Junction & Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	°C

 $R_{DS(ON)}$  vs.  $V_{GS}$ 

Gate Charge



**Electrical Characteristics (@  $T_J = 25^\circ\text{C}$  unless otherwise specified)**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>STATIC PARAMETERS</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	40			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{DS} = 32\text{V}, V_{GS} = 0\text{V}$ $T_J = 55^\circ\text{C}$			1.0 5.0	$\mu\text{A}$
Gate-Body Leakage Current	$I_{GSS}$	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$			$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1.2	1.5	2.5	V
Static Drain-Source ON-Resistance	$R_{DS(\text{ON})}$	$V_{GS} = 10\text{V}, I_D = 20\text{A}$ $V_{GS} = 4.5\text{V}, I_D = 15\text{A}$		0.83 1.2	1.0 1.6	$\text{m}\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS} = 5\text{V}, I_D = 20\text{A}$		132		S
Diode Forward Voltage	$V_{SD}$	$I_S = 1\text{A}, V_{GS} = 0\text{V}$		0.65	1.0	V
Diode Continuous Current	$I_S$	$T_C = 25^\circ\text{C}$			96	A
<b>DYNAMIC PARAMETERS<sup>(5)</sup></b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0\text{V}, V_{DS} = 20\text{V}, f = 1\text{MHz}$		5490		pF
Output Capacitance	$C_{oss}$			3080		pF
Reverse Transfer Capacitance	$C_{rss}$			125		pF
Gate Resistance	$R_g$	$V_{GS} = 0\text{V}, V_{DS} = 0\text{V}, f = 1\text{MHz}$		2.1		$\Omega$
<b>SWITCHING PARAMETERS<sup>(5)</sup></b>						
Total Gate Charge (@ $V_{GS} = 10\text{V}$ )	$Q_g$	$V_{GS} = 0 \text{ to } 10\text{V}$ $V_{DS} = 20\text{V}, I_D = 20\text{A}$		82		nC
Total Gate Charge (@ $V_{GS} = 4.5\text{V}$ )	$Q_g$			40.0		nC
Gate Source Charge	$Q_{gs}$			10.1		nC
Gate Drain Charge	$Q_{gd}$			11.0		nC
Turn-On DelayTime	$t_{D(\text{on})}$	$V_{GS} = 10\text{V}, V_{DS} = 20\text{V}$ $R_L = 1.0\Omega, R_{\text{GEN}} = 6\Omega$		8.0		ns
Turn-On Rise Time	$t_r$			15.9		ns
Turn-Off DelayTime	$t_{D(\text{off})}$			109		ns
Turn-Off Fall Time	$t_f$			67		ns
Body Diode Reverse Recovery Time	$t_{rr}$	$I_F = 15\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$		59		ns
Body Diode Reverse Recovery Charge	$Q_{rr}$	$I_F = 15\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$		50		nC

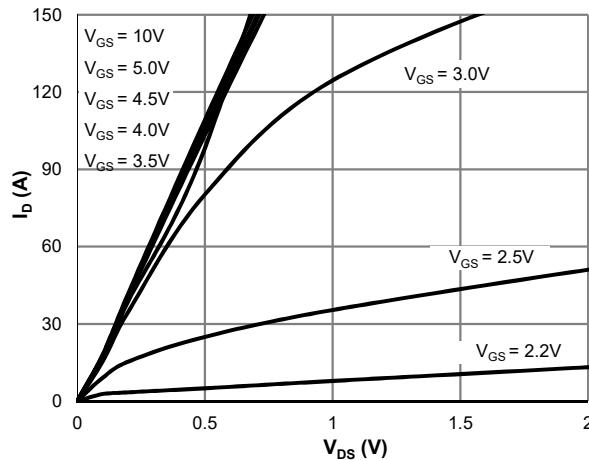
**Thermal Performance**

Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	45	55	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.0	1.3	$^\circ\text{C/W}$

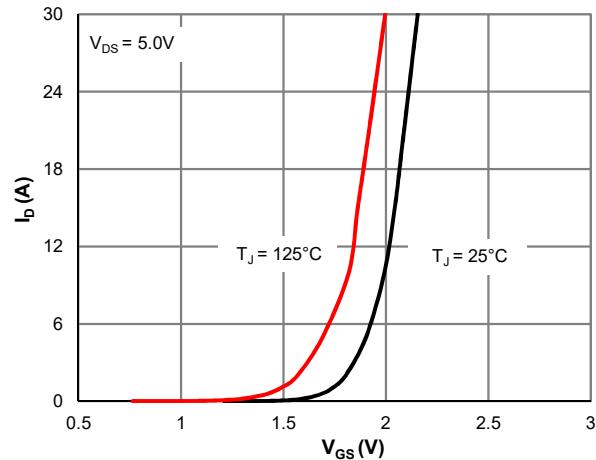
**Notes:**

1. Computed continuous current assumes the condition of  $T_{J_{\text{Max}}}$  while the actual continuous current depends on the thermal & electro-mechanical application board design.
2. This single-pulse measurement was taken under  $T_{J_{\text{Max}}} = 150^\circ\text{C}$ .
3. This single-pulse measurement was taken under the following condition [ $L = 300\mu\text{H}, V_{GS} = 10\text{V}, V_{DS} = 20\text{V}$ ] while its value is limited by  $T_{J_{\text{Max}}} = 150^\circ\text{C}$ .
4. The power dissipation  $P_D$  is based on  $T_{J_{\text{Max}}} = 150^\circ\text{C}$ .
5. This value is guaranteed by design hence it is not included in the production test.
6. Continuous current rating is limited by the package used.

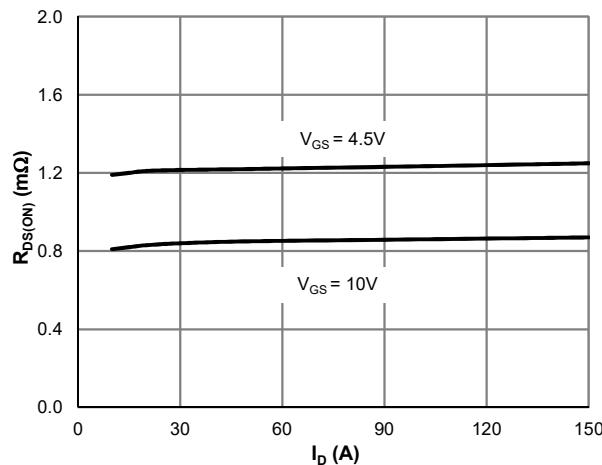
### Typical Electrical & Thermal Characteristics



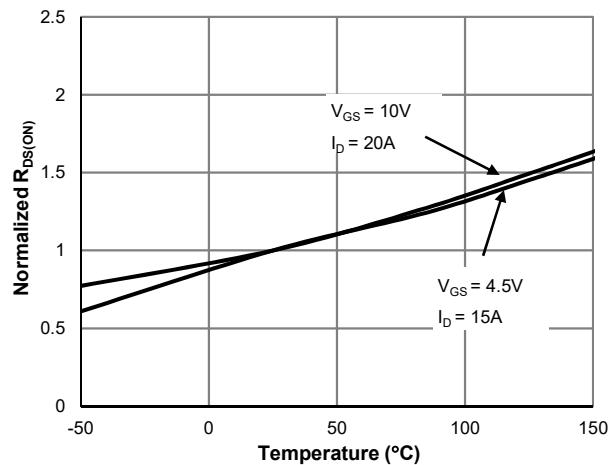
**Figure 1: Saturation Characteristics**



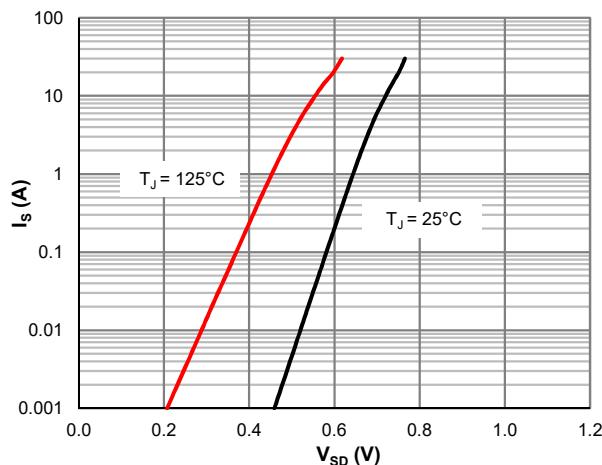
**Figure 2: Transfer Characteristics**



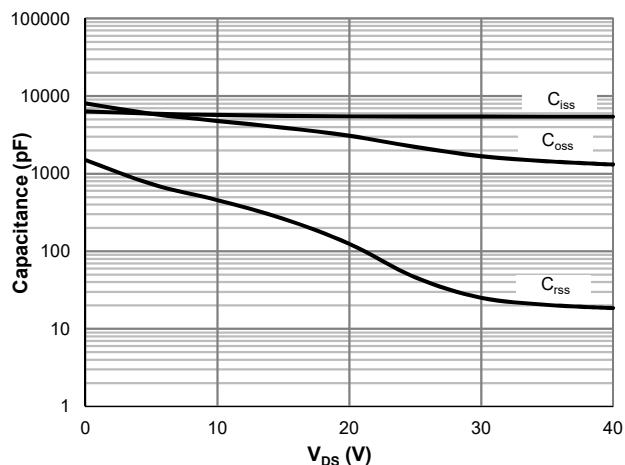
**Figure 3:  $R_{DS(\text{ON})}$  vs. Drain Current**



**Figure 4:  $R_{DS(\text{ON})}$  vs. Junction Temperature**

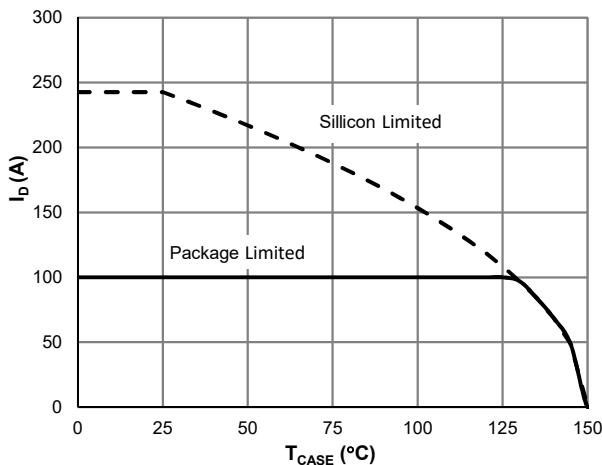


**Figure 5: Body-Diode Characteristics**

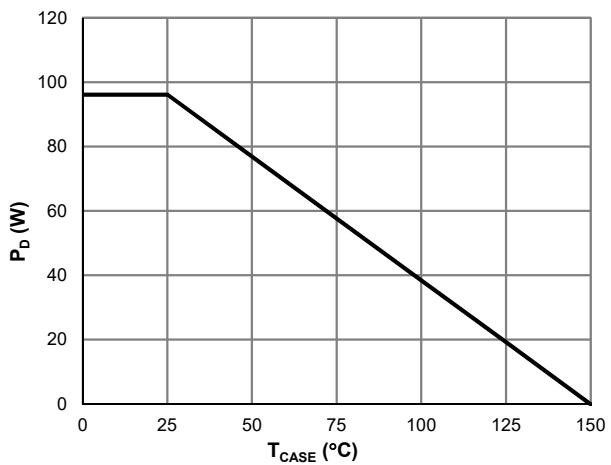


**Figure 6: Capacitance Characteristics**

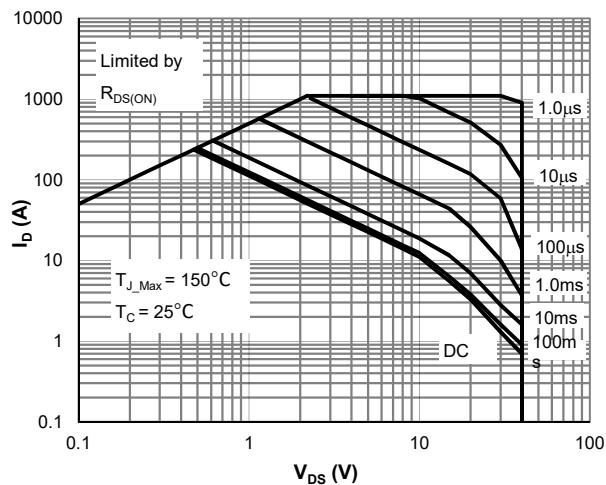
### Typical Electrical & Thermal Characteristics



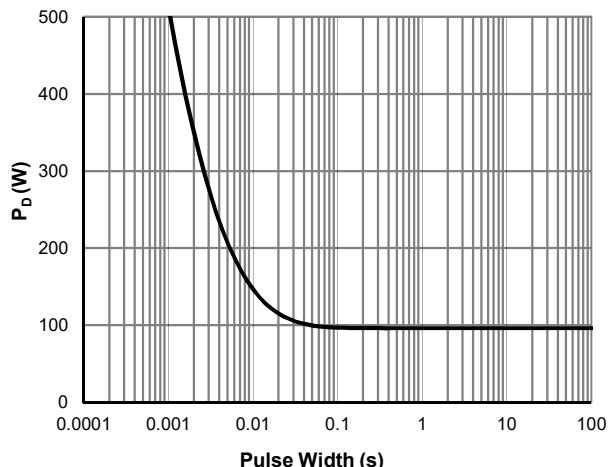
**Figure 7: Current De-rating**



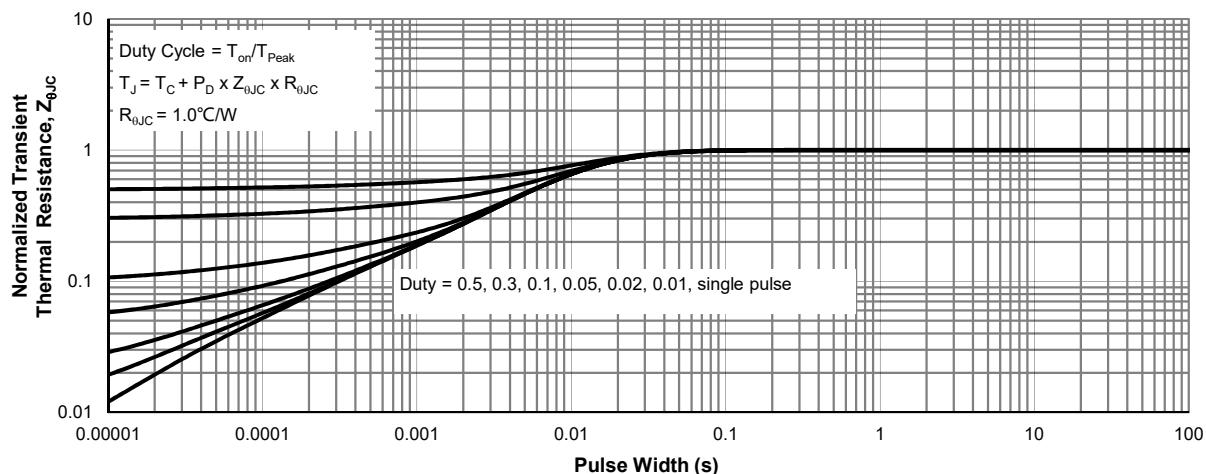
**Figure 8: Power De-rating**



**Figure 9: Maximum Safe Operating Area**



**Figure 10: Single Pulse Power Rating, Junction-to-Case**

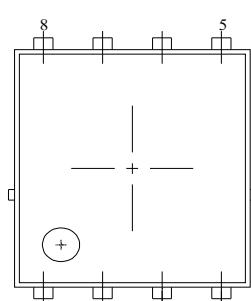


**Figure 11: Normalized Maximum Transient Thermal Impedance**

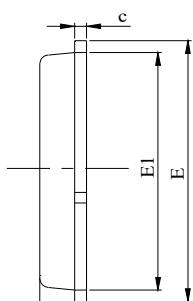


## PDFN5x6-8L Package Information

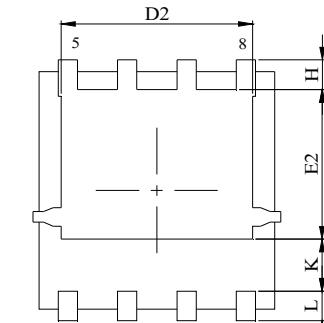
## Package Outline



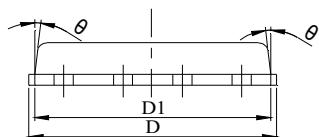
Top View



Side View



Bottom View



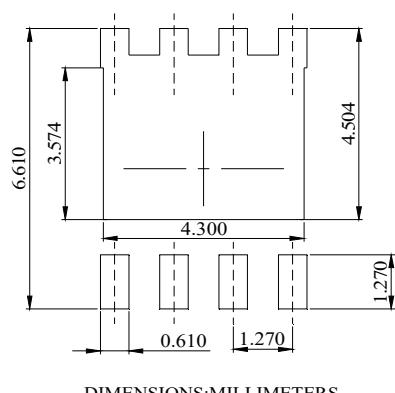
Front View

## NOTES:

1. Dimension and tolerance per ASME Y14.5M, 1994.
2. All dimensions in millimeter (angle in degree).
3. Dimensions D1 and E1 do not include mold flash protrusions or gate burrs.

DIM.	MILLIMETER		
	MIN.	NOM.	MAX.
A	0.90	1.00	1.10
b	0.31	0.41	0.51
c	0.20	0.25	0.30
D	5.00	5.20	5.40
D1	4.95	5.05	5.15
D2	4.00	4.10	4.20
E	6.05	6.15	6.25
E1	5.50	5.60	5.70
E2	3.42	3.53	3.63
e	1.27BSC		
H	0.60	0.70	0.80
L	0.50	0.70	0.80
$\theta$	-	-	10°

## Recommended Soldering Footprint



DIMENSIONS:MILLIMETERS

单击下面可查看定价，库存，交付和生命周期等信息

[>>JJW\(捷捷微\)](#)